

ITC



Docket No.: 50432-330

PATENT

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Application of	:	Customer Number: 20277
Minh Van NGO, et al.	:	Confirmation Number: 1043
Application No.: 10/774,418	:	Group Art Unit: 2812
Filed: February 10, 2004	:	Examiner: Berry, Renee R

For: METHOD OF TREATING INLAID COPPER FOR IMPROVED CAPPING LAYER  
ADHESION WITHOUT DAMAGING POROUS LOW-K MATERIALS

**REQUEST FOR RECONSIDERATION**

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

Reconsideration of the rejection under 35 U.S.C. § 103 imposed in the Office Action dated  
October 7, 2004 is solicited in light of the following Remarks.